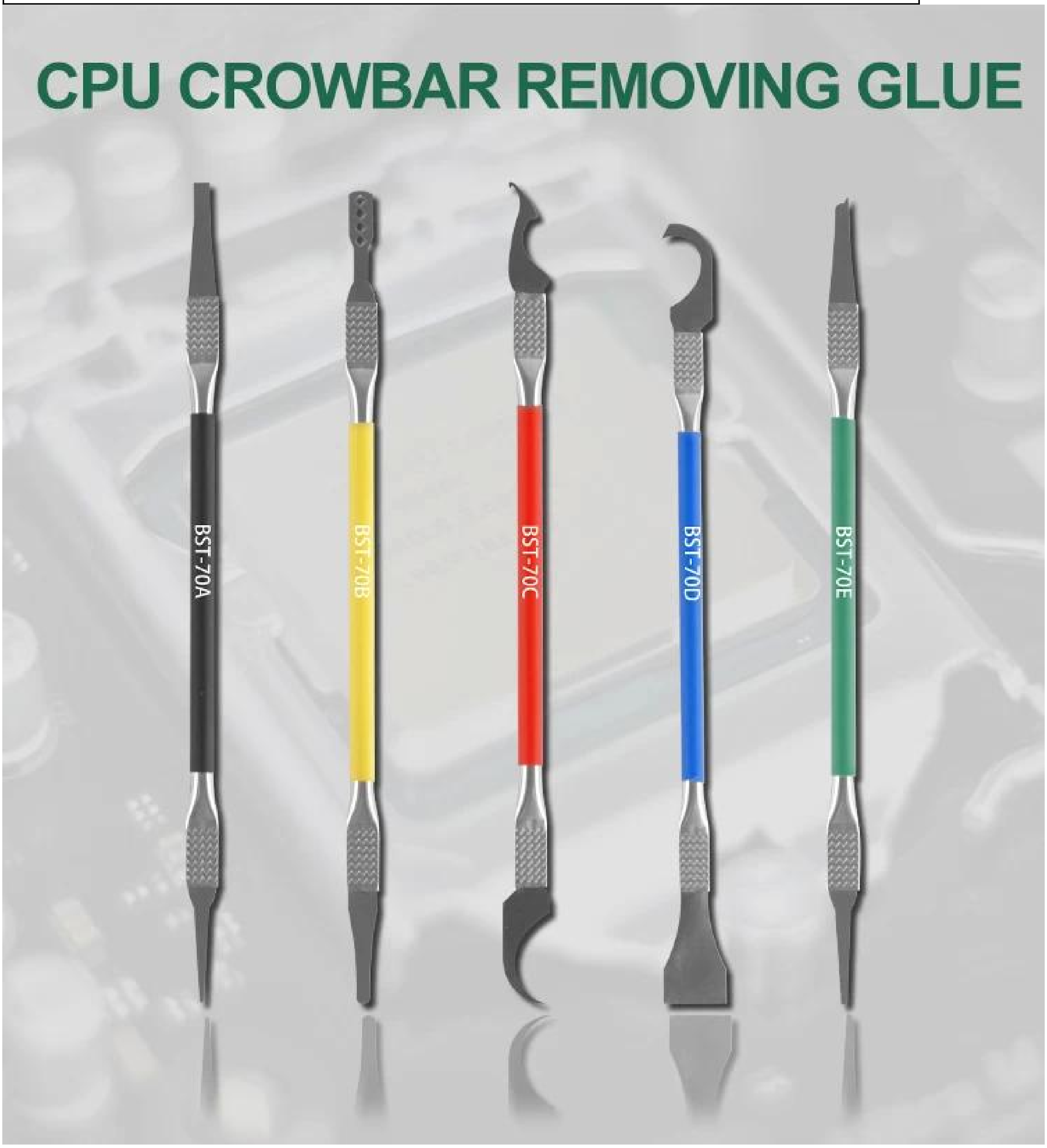


製品説明

• CPU 、IC 、BGAの取り外し、およびCPUのための特別なBlack Glue Cleaner
• ブレードはステンレス製
• 10個の複数の超薄型ブレード（0.7mm）、気まぐれな、それは最後にチップとiphoneの回路基板の間で容易にすることができます、ポイントを引き出すことは容易ではないです。

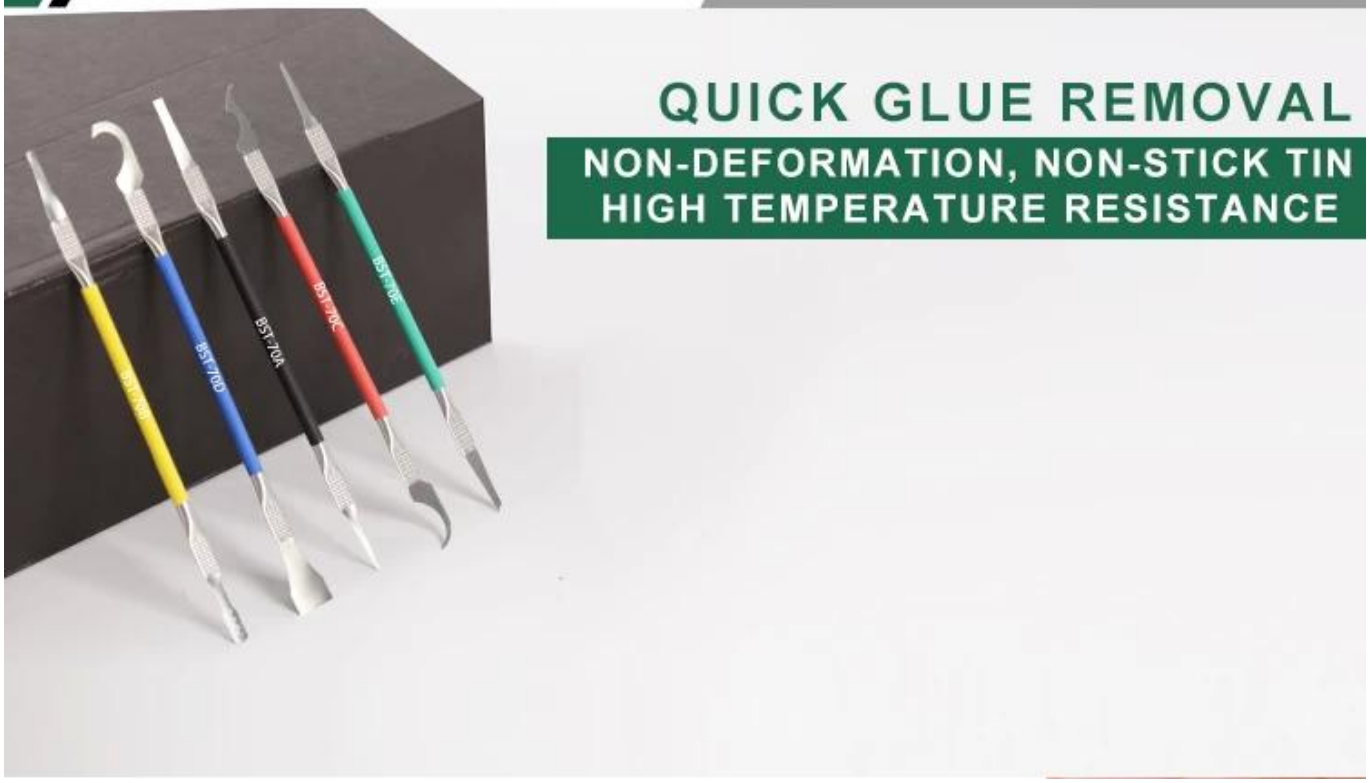
Product Usage

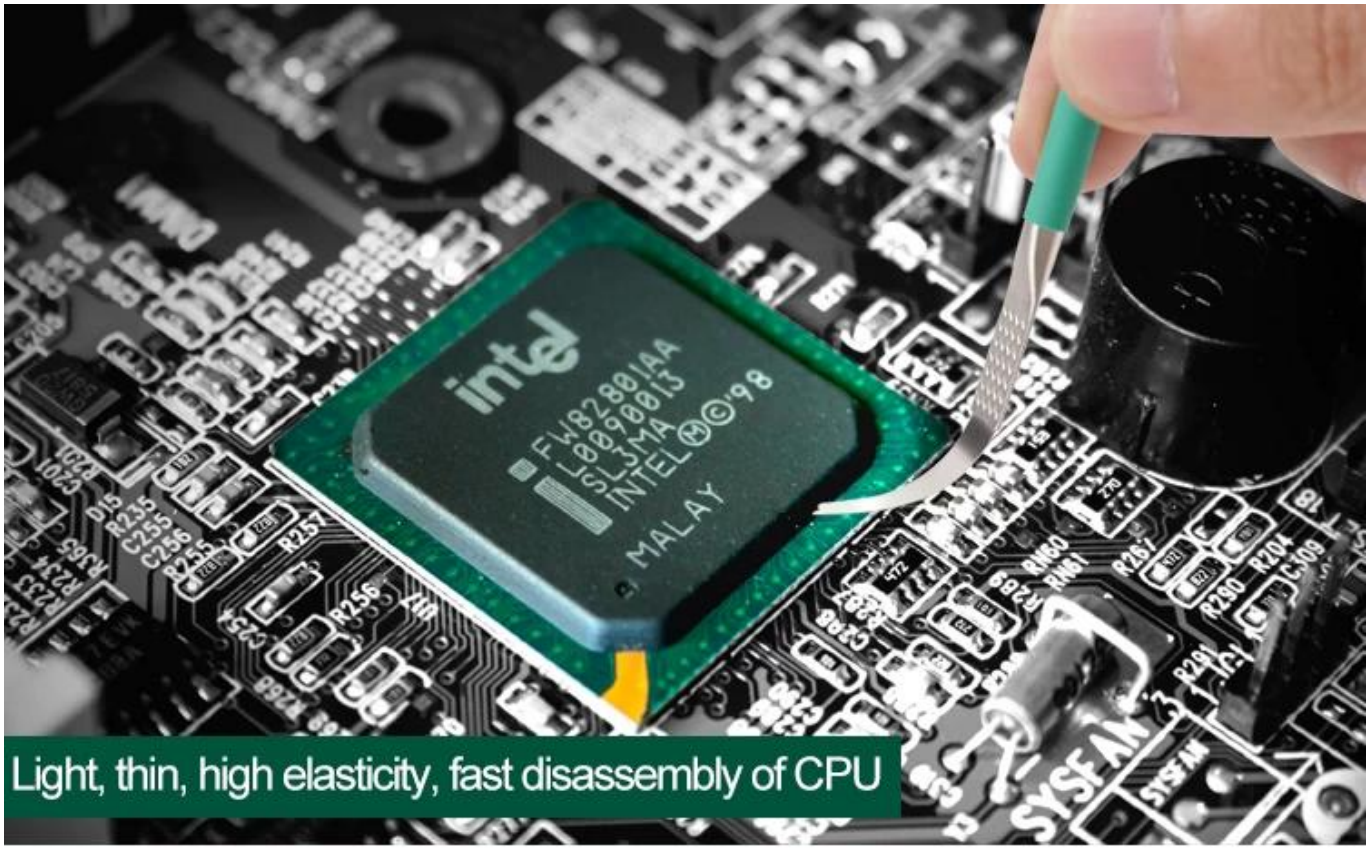
MATERIAL	stainless steel
WEIGHT	22g
MODEL	BST-70
PACKAGING SIZE	211 X 69mm
PRODUCT TYPE	crowbar

▼CHARACTERISTICS

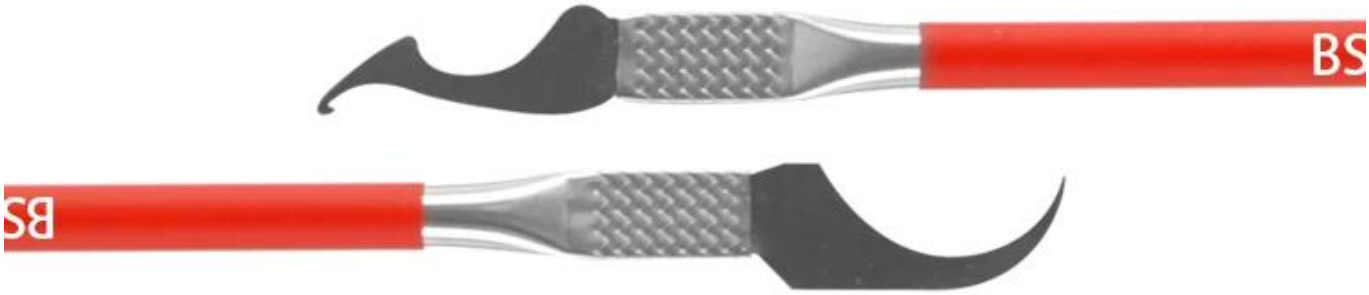
Special for cpu disassembly. The cutter head is made of stainless steel with high temperature resistance. 0.7 mm thick, light and high toughness. Various cutter heads meet the cpu removal function of removing glue, reballing tin...

PRODUCT INFORMATION

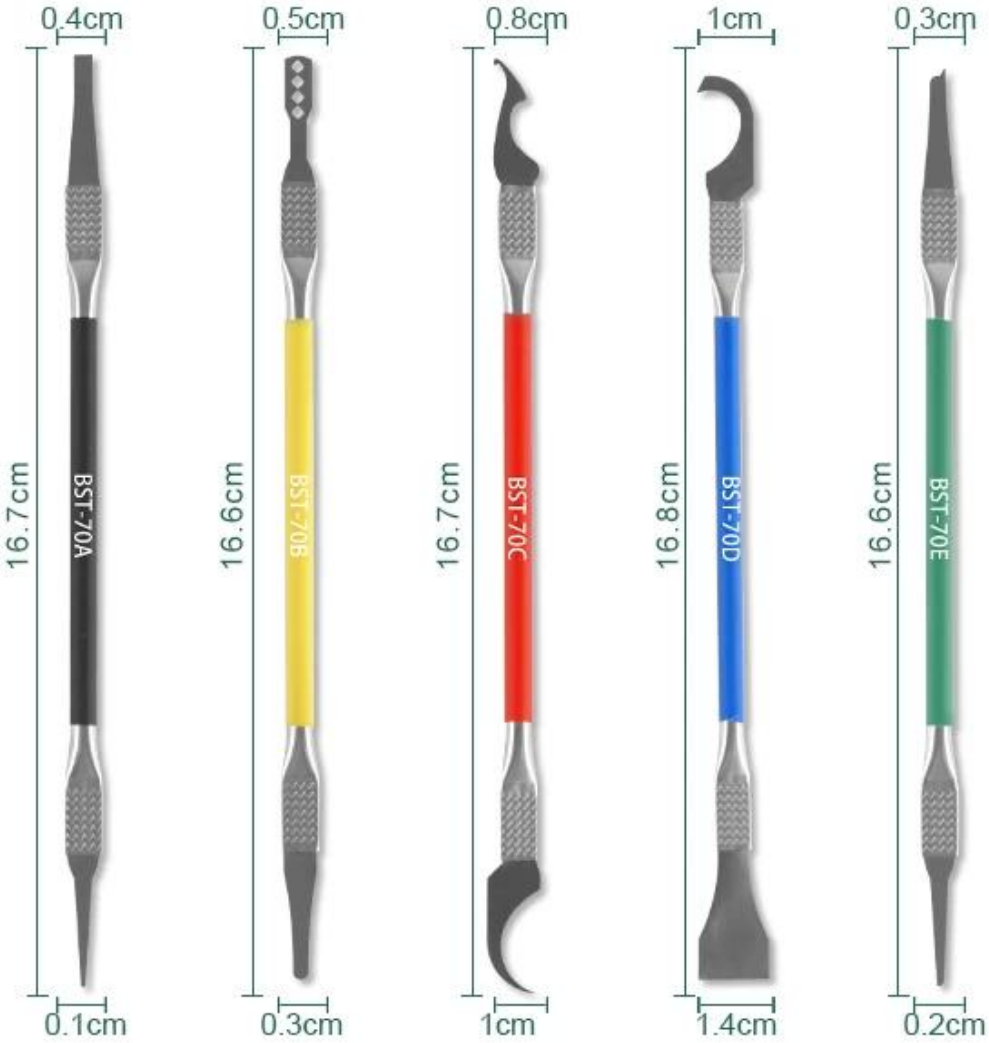


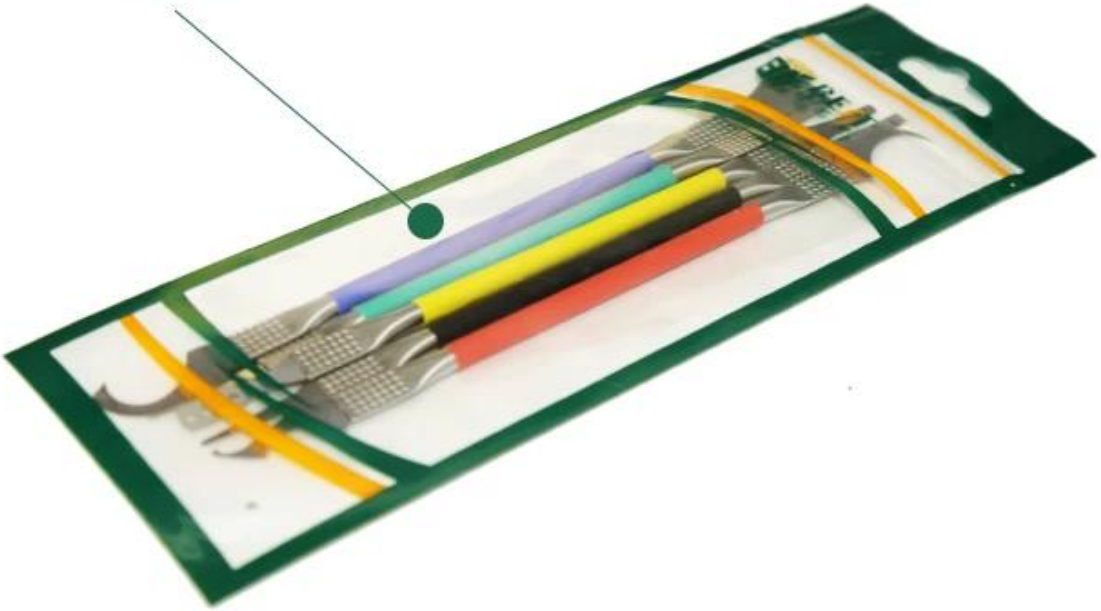


DOUBLE-SIDED HEADS MEET DIFFERENT DEMANDS



PRODUCT SIZE



Thin to 0.07mm

Packing specification